## **Supporting Information**

## (111) Facet-engineered SnO<sub>2</sub> as Electron Transport Layer for Efficient and Stable Perovskite Solar Cells

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Fig. S1 XRD pattern of SnO(OH)<sub>2</sub> powder<sup>1,2</sup> extracted from SnO<sub>2</sub> precursor at 120 °C.



Fig. S2 I-V curves of the T-SnO<sub>2</sub> and C-SnO<sub>2</sub> thin films.

The optical band gap of the the T-SnO<sub>2</sub>, C-SnO<sub>2</sub> and CsFAMA films are calculated using the UV-vis spectra fit to tauc equation<sup>3</sup>

$$(\alpha h\nu)^n = A(h\nu - E_g)$$

Where  $\alpha$  is the absorption coefficient calculated as  $\alpha = 2.303 \frac{A}{d} = -2.303 \frac{1}{d} \log \frac{1}{T}$ , A is the absorbance, T is the transmittance and d is the thickness of the film. The optical band gap of the T-SnO<sub>2</sub>, C-SnO<sub>2</sub> and CsFAMA films are calculated to 4.01, 4.10 and 1.61 eV, respectively (Fig. 2d & S2).

The valance band maximum  $(E_v)$  was determined by the following equation<sup>4</sup>

$$E_v = (E_{cutoff} - HOS) - hv$$

The  $E_{cutoff}$  and HOS (higheat occupied state) positions are indicated in Fig. 2e & S2. As expacted, the  $E_v$  values of the T-SnO<sub>2</sub>, C-SnO<sub>2</sub> and CsFAMA films are calculated to be -8.10, -8.04 and -5.40 eV, respectively.



Fig. S3 UV-vis absorption spectrum and UPS spectrum of CsFAMA film.



**Fig. S4** The 2d and 3d AFM images of (a) T-SnO<sub>2</sub> and (b) C-SnO<sub>2</sub> thin film on FTO coated glass substrate.



Fig. S5 PL spectrum of pristine CsFAMA film.



Fig. S6 TRPL spectrum of pristine CsFAMA film.

Table S1: The fitting parameters of TRPL spectra

Sample	A <sub>1</sub>	$\tau_1(ns)$	A <sub>2</sub>	τ <sub>2</sub> (ns)	A <sub>3</sub>	τ3 (ns)	τ <sub>ave</sub> (ns)
CsFAMA	0.57	4.70	0.42	41.42	-	-	36.53
T-SnO <sub>2</sub> /CsFAMA	0.95	1.23	0.04	6.38	0.007	29.07	5.52
C-SnO <sub>2</sub> /CsFAMA	0.79	0.63	0.04	3.79	0.005	17.49	3.28

The average lifetime was determined by the following equation<sup>5</sup>

$$< au_{ave}>=rac{\sum_{i=1,2,3}A_{i} au_{i}^{2}}{\sum_{i=1,2,3}A_{i} au_{i}}$$

where  $A_i$  is the pre-exponential factor and  $\tau_i$  is the average lifetime.

Sample	VTFL (V)	Ntrap (cm <sup>-3</sup> )			
T-SnO <sub>2</sub>	0.564	$1.80 \times 10^{16}$			
C-SnO <sub>2</sub>	0.445	$1.42 \times 10^{16}$			

**Table S2:** The parameters of the SCLC for different electron-only devices.

The density of trap states was calculated using the following equation<sup>6</sup>

$$N_{trap} = \frac{2\varepsilon_r \varepsilon_0 V_{TFL}}{eL^2}$$

where  $V_{TFL}$  is the trap filling limit voltage, L is the thickness of the perovskite layer,  $\varepsilon_r$  is the relative dielectric constant of the perovskite layer ( $\varepsilon_r \approx 26$ ),  $\varepsilon_0$  is the vacuum dielectric constant, and *e* is the amount of electric charge.



Fig, S7 (a) TSC profile of PSCs, and (b) Arrhenius plot obtained from the TSC profile with different ETLs in PSCs. Each dashed line represents the slope of the profile.

To understand the recombination process in the PSC with  $C-SnO_2$  ETL, we conducted thermally stimulated current (TSC) analysis (see Fig. S7a). The activation energy of the trap states was calculated from the slope of the Arrhenius plot (see Fig. S7b) of the TSC profile, using the following relation<sup>7</sup>

$$I_{\rm TSC} \propto \exp\left(-\frac{E_{\rm A}}{k_{\rm B}T}\right)$$

where  $E_A$ ,  $k_B$ , and T are the activation energy, Boltzmann constant, and temperature, respectively.

T- SnO <sub>2</sub>	V <sub>oc</sub> (V)	J <sub>SC</sub> (mA.cm <sup>-2</sup> )	FF (%)	РСЕ (%)	C- SnO <sub>2</sub>	V <sub>oc</sub> (V)	J <sub>SC</sub> (mA.cm <sup>-2</sup> )	FF (%)	РСЕ (%)
1	1.08	23.67	76.5	19.64	1	1.10	23.89	77.3	20.34
2	1.08	23.53	76.3	19.38	2	1.10	23.76	76.9	20.09
3	1.07	23.87	75.8	19.36	3	1.10	23.89	75.3	19.78
4	1.09	23.69	74.1	19.13	4	1.11	23.54	75.6	19.75
5	1.08	23.45	74.3	18.81	5	1.10	23.48	76.3	19.70
6	1.07	23.58	73.8	18.62	6	1.10	23.64	75.1	19.53
7	1.08	23.33	72.9	18.55	7	1.10	23.67	74.9	19.50
8	1.07	23.68	73.2	18.54	8	1.09	23.93	74.7	19.48
9	1.08	23.33	73.1	18.42	9	1.10	23.83	74.3	19.47
10	1.06	23.59	73.3	18.33	10	1.11	23.06	75.5	19.32
11	1.07	23.47	72.6	18.24	11	1.11	23.23	74.8	19.29
12	1.06	23.77	72.3	18.22	12	1.10	23.63	74.2	19.28
13	1.06	23.46	72.5	18.03	13	1.11	23.14	74.8	19.21
14	1.07	23.11	72.1	17.83	14	1.09	23.67	74.0	19.06
15	1.06	23.34	71.6	17.72	15	1.10	23.46	73.6	18.99
16	1.05	23.53	71.5	17.66	16	1.09	23.46	73.3	18.74
17	1.07	23.48	70.3	17.67	17	1.08	23.54	73.5	18.68
18	1.06	23.41	70.7	17.55	18	1.10	23.14	73.1	18.61
19	1.06	23.64	69.5	17.42	19	1.11	23.06	72.6	18.58
20	1.08	23.45	68.5	17.35	20	1.09	23.34	72.9	18.54
21	1.07	23.61	68.4	17.28	21	1.09	23.27	72.8	18.46
22	1.07	23.27	69.1	17.21	22	1.08	23.45	72.6	18.38
23	1.06	23.64	66.9	16.76	23	1.11	22.86	72.3	18.34

**Table S3:** J-V data of 30 independent devices.

24	1.05	24.34	64.7	16.54	24	1.10	23.56	70.3	18.21
25	1.06	23.71	67.1	16.87	25	1.09	23.85	69.1	17.96
26	1.06	23.49	66.1	16.46	26	1.10	23.66	68.3	17.76
27	1.06	23.12	66.3	16.24	27	1.09	24.14	66.2	17.42
28	1.08	22.76	64.2	15.78	28	1.10	23.87	65.4	17.18
29	1.05	23.22	64.6	15.75	29	1.10	23.36	65.8	16.90
30	1.05	23.05	63.6	15.39	30	1.08	23.06	65.3	16.26

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